

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub>	50	V
Average Rectified Output Current	I <sub>O</sub>	10	A
Non-Repetitive Peak Forward Surge Current 8.3ms	I <sub>FSM</sub>	300	A

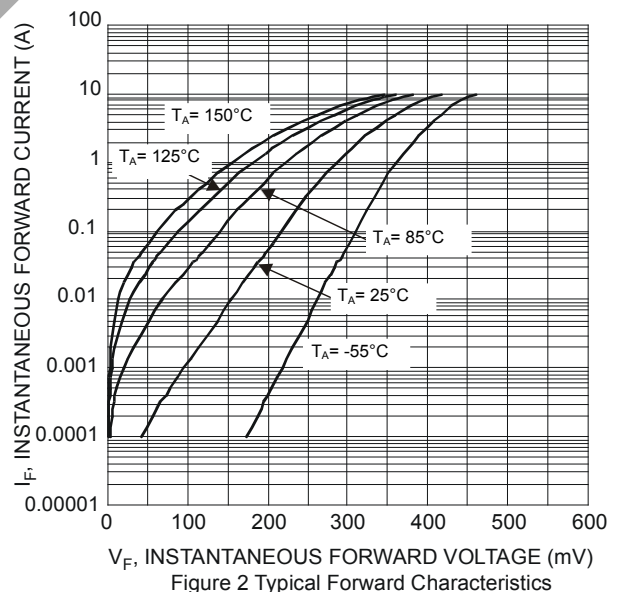
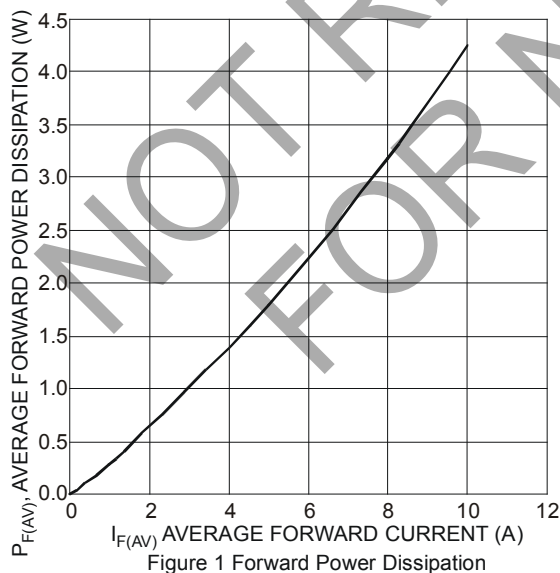
**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 6)	R <sub>θJA</sub>	18	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	R <sub>θJC</sub>	2	°C/W
Typical Thermal Resistance Junction to Lead (Notes 6 and 7)	R <sub>θJL</sub>	4	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	—	0.31	—	V	I <sub>F</sub> = 5A, T <sub>J</sub> = +85°C
		—	0.42	0.47		I <sub>F</sub> = 10A, T <sub>J</sub> = +25°C
		—	0.36	0.41		I <sub>F</sub> = 10A, T <sub>J</sub> = +125°C
Leakage Current (Note 8)	I <sub>R</sub>	—	0.06	0.15	mA	V <sub>R</sub> = 50V, T <sub>J</sub> = +25°C
		—	2	12		V <sub>R</sub> = 50V, T <sub>J</sub> = +85°C
		—	15	50		V <sub>R</sub> = 50V, T <sub>J</sub> = +125°C

Notes: 6. Device mounted on FR4 PCB with 1inch copper pad layout with AL substrate and additional HK1 (37mm x 55mm x15mm).  
 7. Junction to Lead (Cathode Terminal).  
 8. Short duration pulse test used to minimize self-heating effect.



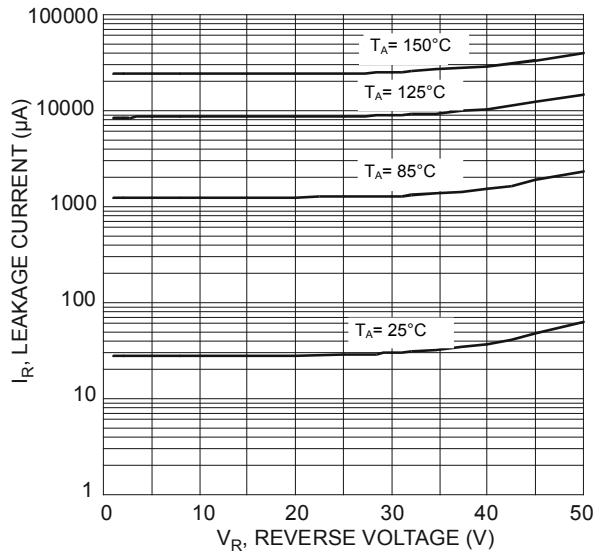


Figure 3 Typical Reverse Characteristics

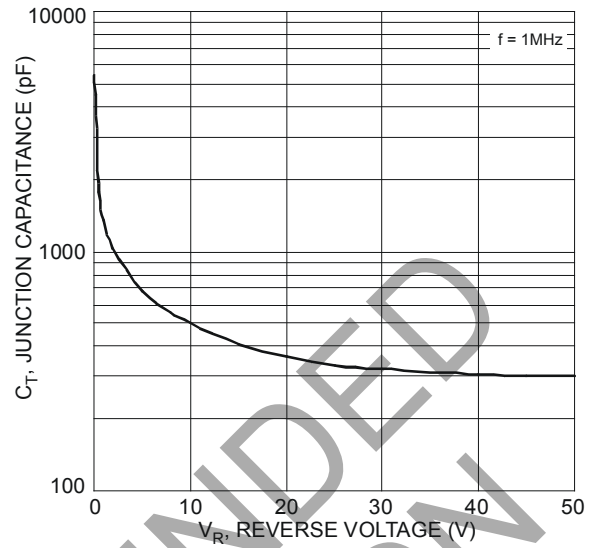


Figure 4 Typical Junction Capacitance

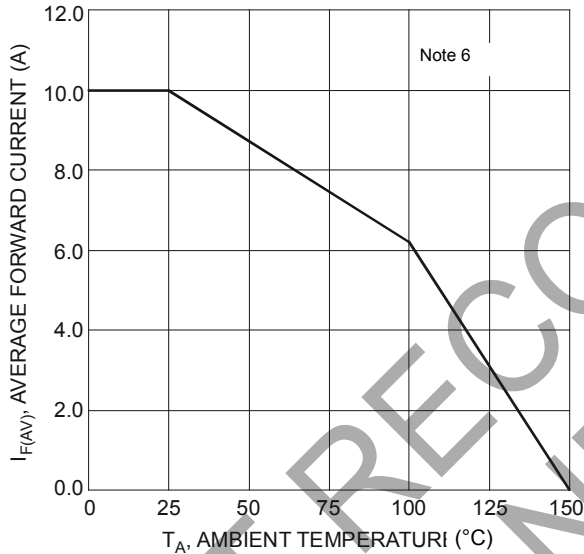
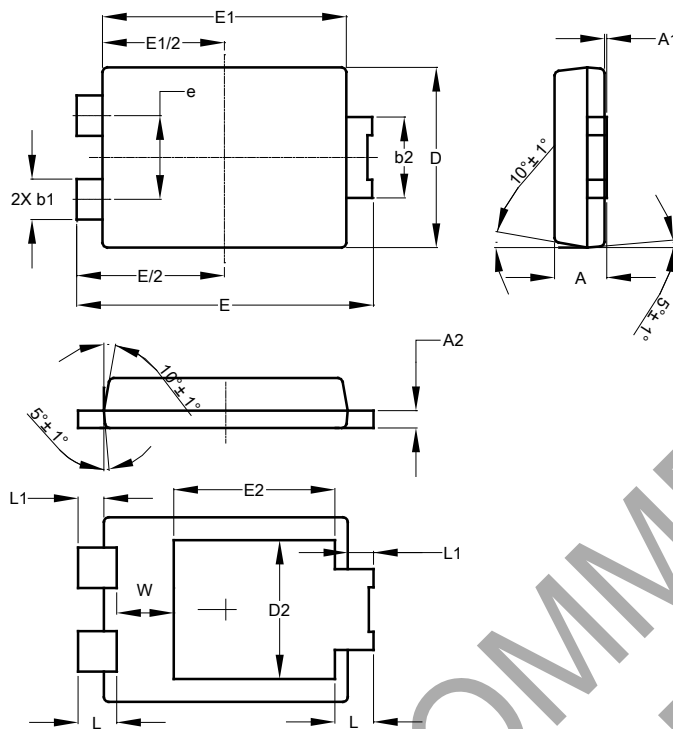


Figure 5 Forward Current Derating Curve

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI5**

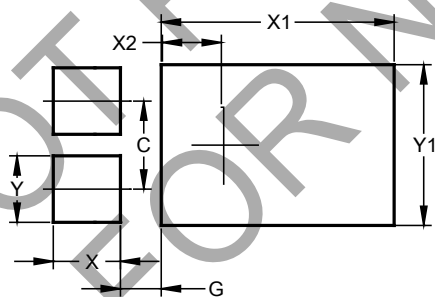
PowerDI5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A1	0.00	0.05	--
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	--	--	3.054
E	6.40	6.60	6.51
e	--	--	1.84
E1	5.30	5.45	5.37
E2	--	--	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255

**All Dimensions in mm**

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

## PowerDI5



Dimensions	Value (in mm)
C	1.840
G	0.852
X	1.400
X1	4.860
X2	1.310
Y	1.390
Y1	3.360

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